



Description

The 74LVC1G04 is a single inverter gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down.

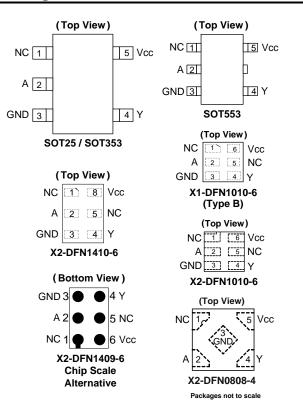
The gate performs the positive Boolean function:

 $Y = \overline{A}$

Features

- Wide Supply Voltage Range from 1.65 to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS Low Power Consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs Accept Up to 5.5V
- ESD Protection Tested per JESD 22
 - Exceeds 200-V Machine Model (A115)
 - Exceeds 2000-V Human Body Model (A114)
 - Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class I
- Range of Package Options
- Direct Interface with TTL Levels
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide Array of Products Such as.
 - PCs, Networking, Notebooks, Netbooks, PDAs
 - Tablet Computers, E-readers
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set Top Box
 - Cell Phones, Personal Navigation / GPS
 - MP3 Players ,Cameras, Video Recorders

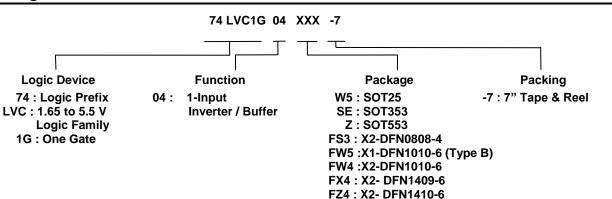
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information (Note 4)



Part Number	Deekere Cede	Package	Package	7" Tape ar	nd Reel
Part Number Package Code		(Notes 5 & 6)	Size	Quantity	Part Number Suffix
74LVC1G04W5-7	W5	SOT25	3.0mm x 2.8mm x 1.2mm 0.95 mm lead pitch	3,000/Tape & Reel	-7
74LVC1G04SE-7	SE	SOT353	2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch	3,000/Tape & Reel	-7
74LVC1G04Z-7	Z	SOT553	1.6mm x 1.6 mm x 0.62mm 0.5 mm lead pitch	4,000/Tape & Reel	-7
74LVC1G04FS3-7	FS3	X2-DFN0808-4	0.8mm x 0.8 mm x 0.35mm 0.5 mm pad pitch (diamond)	5,000/Tape & Reel	-7
74LVC1G04FW5-7	FW5	X1-DFN1010-6 (Type B)	1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74LVC1G04FW4-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74LVC1G04FX4-7	FX4	X2-DFN1409-6 Chip scale alternative	1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7
74LVC1G04FZ4-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

5. Pad layout as shown on Diodes Inc. suggested pad layout document which can be found on our website at http://www.diodes.com/package-outlines.html 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf.

Pin Descriptions

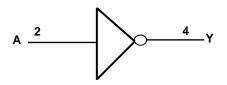
Notes:

Pin Name	Description	
NC	No Connection	
А	Data Input	
GND	Ground	
Y	Data Output	
V _{CC}	Supply Voltage	

Function Table

Inputs	Output
Α	Y
Н	L
L	Н

Logic Diagram





Absolute Maximum Ratings (Notes 7 & 8) (@T _A = +25°C, unless otherwise specified.)	
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Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage Applied to Output in High Impedance or IOFF State	-0.5 to 6.5	V
Vo	Voltage Applied to Output in High or Low State.	-0.5 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current VI < 0	-50	mA
I _{ОК}	Output Clamp Current	-50	mA
lo	Continuous Output Current	±50	mA
I _{CC,} I _{GN}	Continuous Current Through V _{CC} or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Notes: 7. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device

8. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

Recommended Operating Conditions (Note 9) (@T_A = +25°C, unless otherwise specified.)

Symbol		Parameter	Min	Max	Unit
Mala	Operating Voltage	Operating	1.65	5.5	V
Vcc	Operating voltage	Data retention only	1.5	—	V
		V _{CC} = 1.65V to 1.95V	$0.65 \times V_{CC}$	—	
V		$V_{CC} = 2.3V$ to 2.7V	1.7	—	V
VIH	High-Level Input Voltage	$V_{CC} = 3V$ to 3.6V	2	—	v
		$V_{CC} = 4.5V$ to 5.5V	0.7 x V _{CC}	—	
		V _{CC} = 1.65V to 1.95V	—	0.35 x V _{CC}	
		V _{CC} = 2.3V to 2.7V	—	0.7	V
VIL	Low-Level Input Voltage	$V_{CC} = 3V$ to 3.6V	—	0.8	V
		V _{CC} = 4.5V to 5.5V	—	0.3 x V _{CC}	
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	Vcc	V
		V _{CC} = 1.65V	—	-4	
		$V_{CC} = 2.3V$	—	-8	
	Llich Louis Output Current	V _{CC} = 2.7V	—	-12	mA
I _{ОН}	High-Level Output Current		_	-16	mA
		V _{CC} = 3V		-24	
		$V_{CC} = 4.5V$	—	-32	
		$V_{CC} = 1.65 V$	—	4	
		$V_{CC} = 2.3 V$	—	8	
I _{OL}	Low-Level Output Current	$V_{CC} = 2.7 V$	—	12	mA
IOL		$V_{CC} = 3V$	—	16	IIIA
		VCC = 5V	—	24	
		$V_{CC} = 4.5V$	—	32	
		$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$	—	20	
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.3V \pm 0.3V$	—	10	ns/V
		$V_{CC} = 5V \pm 0.5V$	—	5	
T _A	Operating Free-Air Temperature	_	-40	+125	°C

Note: 9. Unused inputs should be held at $V_{CC}\, or \, Ground.$



Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = +25^{\circ}C$)

Symbol	Parameter	Test Conditions	N N	-40	-40°C to +85°C			-40°C to +125°C	
Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур.	Max	Min	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} – 0.1		—	$V_{CC} - 0.1$	_	
		I _{OH} = -4mA	1.65V	1.2		—	0.95	_	
		I _{OH} = -8mA	2.3V	1.9		—	1.7	_	
Vон	High-Level Output Voltage	I _{OH} = -12mA	2.7V	2.2		—	1.9	_	V
	Output Voltage	I _{OH} = -16mA	3V	2.4	—	_	2.2	_	
		I _{OH} = -24mA	30	2.3	—	_	2.0	_	
		I _{OH} = -32mA	4.5V	3.8	—	_	3.4	_	
		I _{OL} = 100μA	1.65V to 5.5V	—	—	0.1	—	0.1	
		$I_{OL} = 4mA$	1.65V	—	_	0.45	—	0.7	v
		I _{OL} = 8mA	2.3V	—	_	0.3	—	0.45	
V _{OL}	Low-Level Output Voltage	$I_{OL} = 12mA$	2.7V	—	_	0.4	—	0.6	
	e alpar voltage	$I_{OL} = 16 \text{mA}$	3V	—		0.4	—	0.6	
		I _{OL} = 24mA		—	_	0.55	—	0.8	
		I _{OL} = 32mA	4.5V	—	_	0.55	—	.8	
l _l	Input Current	$V_1 = 5.5 V \text{ or GND}$	0 to 5.5V	—	± 0.1	±5	—	± 100	μA
I _{OFF}	Power Down Leakage Current	V_{I} or $V_{O} = 5.5V$	0V	_	_	±10	_	±200	μA
Icc	Supply Current	V ₁ = 5.5V or GND I _O =0	5.5V	_	0.1	10	_	200	μA
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6V	3V to 5.5V	—	—	500	—	5,000	μA
Ci	Input Capacitance	$V_i = V_{CC} - or GND$	3.3V	_	5	_	—	_	pF

Package Characteristics (All typical values are at V_{CC} = 3.3V, T_A = +25°C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit
		SOT25		—	204	_	
		SOT353		—	371	_	
		SOT553		_	231	_	
0	Thermal Resistance	X2-DFN0808-4	(Note 10)		400	_	°C/W
θ_{JA}	Junction-to-Ambient	X1-DFN1010-6 (Type B)	(Note 10)		435	_	C/vv
		X2-DFN1010-6			445	_	
		X2-DFN1409-6		—	470	_	
		X2-DFN1410-6	410-6		460	_	
		SOT25		—	52	_	
		SOT353		—	143	_	
		SOT553		—	105	_	
0	Thermal Resistance	X2-DFN0808-4	(Note 10)	—	225	_	°C/W
θ_{JC}	Junction-to-Case	X1-DFN1010-6 (Type B)	(Note 10)		250	_	C/vv
		X2-DFN1010-6		—	250	_	
		X2-DFN1409-6		_	275	_	
		X2-DFN1410-6			265		

Note: 10. Test condition for each of the 8 package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Switching Characteristics

Parameter	From To		From To		T _A = -40°C to +85°C			T _A = -40°C to +125°C		Unit
Parameter Input Out	Output	Output V _{CC}	Min	Тур	Max	Min	Max	Unit		
			1.8V ± 0.15V	1.0	3.0	7.5	1.0	9.5		
		A or B Y	2.5V ± 0.2V	0.5	2.0	5.0	0.5	6.5		
t _{pd}	A or B		2.7V	0.5	2.3	5.2	0.5	7.0	ns	
-			3.3V ± 0.3V	0.5	2.0	4.2	0.5	5.5		
		5.0V ± 0.5V	0.5	1.6	3.7	0.5	5.0	7		

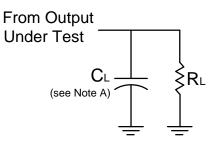
Figure 1 Typical Values at $T_A = +25^{\circ}$ C and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

Operating Characteristics

T _A = +25°C							
Parameter		Test Conditions	V _{CC} = 1.8V	$V_{CC} = 2.5V$	$V_{CC} = 3.3V$	$V_{CC} = 5V$	Unit
	Farameter		Тур	Тур	Тур	Тур	Unit
C_{pd}	Power Dissipation Capacitance	f = 10MHz	16	16	16	16	pF



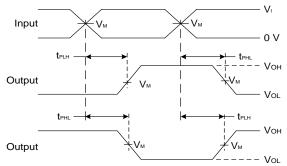
Parameter Measurement Information



N.	Inputs		V		n
Vcc	VI	t _r /t _f	V _M	C∟	RL
1.8V ± 0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1kΩ
2.5V ± 0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
2.7V	Vcc	≤2.5ns	1.5V	50pF	500Ω
3.3V ± 0.3V	3.0V	≤2.5ns	1.5V	50pF	500Ω
5.0V ± 0.5V	Vcc	≤2.5ns	V _{CC} /2	50pF	500Ω



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1 Load Circuit and Voltage Waveforms

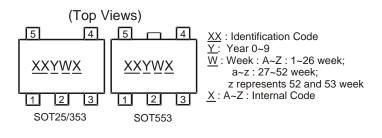
Notes:

- A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 10MHz.
 - C. t_{PLH} and t_{PHL} are the same as t_{PD} .



Marking Information

(1) SOT25, SOT353 and SOT553



Part Number	Package	Identification Code
74LVC1G04W5-7	SOT25	UU
74LVC1G04SE-7	SOT353	UU
74LVC1G04Z-7	SOT553	UU

(2) DFN Packages



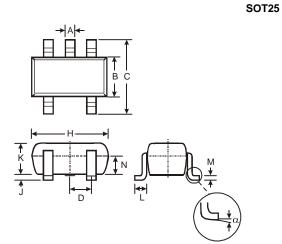
 $\begin{array}{l} \underbrace{XX} : \text{Identification Code} \\ \underline{Y} : \text{ Year } 0~9 \\ \underline{W} : \text{Week} : A~Z: 1~26 \text{ week}; \\ a~z: 27~52 \text{ week}; \\ z \text{ represents } 52 \text{ and } 53 \text{ week} \end{array}$

Ziep	resents 52 and 55	VV 6
<u>X</u> : A~Z :	Internal Code	

Part Number	Package	Identification Code
74LVC1G04FS3-7	X2-DFN0808-4	WU
74LVC1G04FW5-7	X1-DFN1010-6 (Type B)	V4
74LVC1G04FW4-7	X2-DFN1010-6	UU
74LVC1G04FX4-7	X2-DFN1409-6	MC
74LVC1G04FZ4-7	X2-DFN1410-6	UU



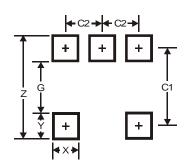
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT25			
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
В	1.50	1.70	1.60
С	2.70	3.00	2.80
D	-	-	0.95
Η	2.90	3.10	3.00
ر	0.013	0.10	0.05
ĸ	1.00	1.30	1.10
1	0.35	0.55	0.40
Σ	0.10	0.20	0.15
Ν	0.70	0.80	0.75
α	0°	8°	1
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

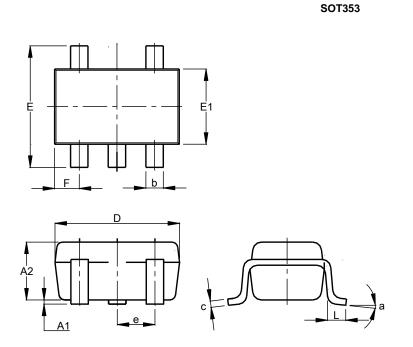


Dimensions	Value
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95

SOT25



Please see http://www.diodes.com/package-outlines.html for the latest version.

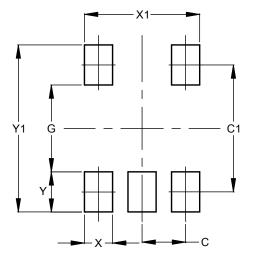


	SOT353		
Dim	Min	Max	Тур
A1	0.00	0.10	0.05
A2	0.90	1.00	1.00
b	0.10	0.30	0.25
С	0.10	0.22	0.11
D	1.80	2.20	2.15
Е	2.00	2.20	2.10
E1	1.15	1.35	1.30
е	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
а	0°	8°	
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

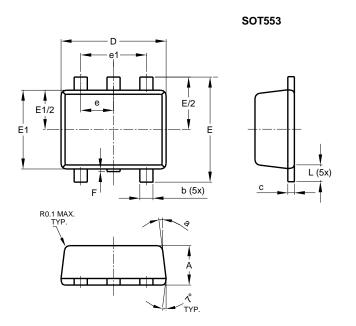
SOT353



Dimensions	Value (in mm)
С	0.650
C1	1.900
G	1.300
X	0.420
X1	1.720
Y	0.600
Y1	2.500



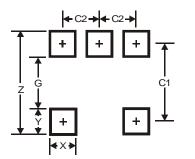
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT553			
Dim	Min	Max	Тур
Α	0.55	0.62	0.60
b	0.15	0.30	0.20
С	0.10	0.18	0.15
D	1.50	1.70	1.60
Ε	1.55	1.70	1.60
E1	1.10	1.25	1.20
е	0.50 BSC		
e1	1.0	00 BS(0
F	0.00	0.10	
L	0.10	0.30	0.20
а	6°	8°	7°
All D	imensio	ns in n	nm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



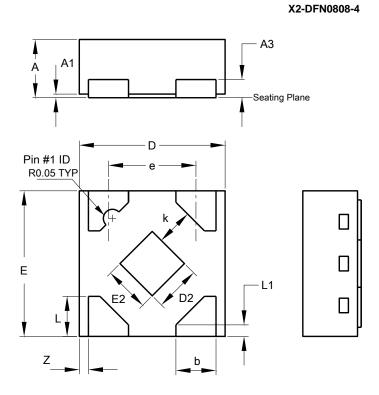
SOT553

Dimensions	Value
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5

74LVC1G04 Document number: DS32198 Rev. 10 - 2 Downloaded from Arrow.com.



Please see http://www.diodes.com/package-outlines.html for the latest version.

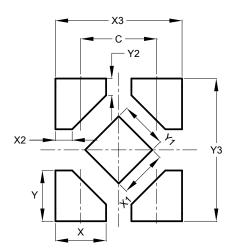


	X2-DFN0808-4				
Dim	Min	Max	Тур		
Α	0.25	0.35	0.30		
A1	0	0.04	0.02		
A3	-	-	0.13		
b	0.17	0.27	0.22		
D	0.75	0.85	0.80		
D2	0.15	0.35	0.25		
Е	0.75	0.85	0.80		
E2	0.15	0.35	0.25		
е	-	-	0.48		
k	0.20	-	-		
L	0.17	0.27	0.22		
L1	0.02	0.12	0.07		
z	-	-	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

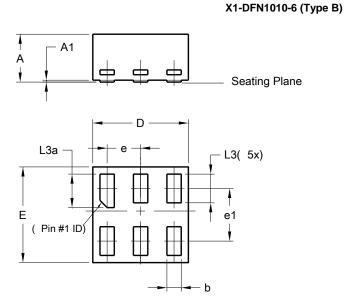
X2-DFN0808-4



Dimensions	Value
С	0.480
Х	0.320
X1	0.300
X2	0.106
X3	0.800
Y	0.320
Y1	0.300
Y2	0.106
Y3	0.900



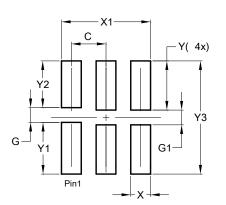
Please see http://www.diodes.com/package-outlines.html for the latest version.



	X1-DFN1010-6 (Type B)			
Dim	Min	Max	Тур	
Α	-	0.50	0.39	
A1	-	0.04	-	
b	0.12	0.20	0.15	
D	0.95	1.050	1.00	
Е	0.95	1.050	1.00	
е	0.35 BSC			
e1	0.55 BSC			
L3	0.27	0.30	0.30	
L3a	0.32	0.40	0.35	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

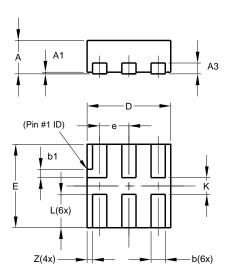


X1-DFN1010-6 (Type B)

Dimensions	Value
	(in mm)
С	0.350
G	0.150
G1	0.150
Х	0.200
X1	0.900
Y	0.500
Y1	0.525
Y2	0.475
Y3	1.150



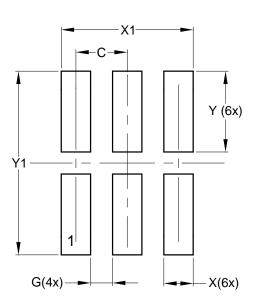
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1010-6			
Dim	Min	Max	Тур
Α	_	0.40	0.39
A1	0.00	0.05	0.02
A3			0.13
b	0.14	0.20	0.17
b1	0.05	0.15	0.10
D	0.95	1.05	1.00
E	0.95	1.05	1.00
е			0.35
L	0.35	0.45	0.40
K	0.15		
Z			0.065
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1010-6

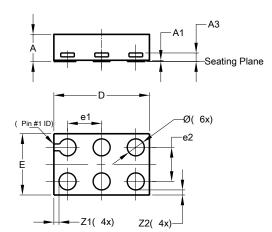
X2-DFN1010-6

Dimensions	Value (in mm)	
С	0.350	
G	0.150	
Х	0.200	
X1	0.900	
Y	0.550	
Y1	1.250	



Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1409-6 CHIP SCALE ALTERNATIVE

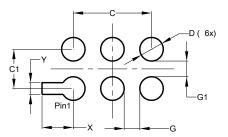


X2-DFN1409-6			
Dim	Min	Max	Тур
Α	-	0.40	0.39
A1	0	0.05	0.02
A3	-	-	0.13
Ø	0.20	0.30	0.25
D	1.35	1.45	1.40
Е	0.85	0.95	0.90
e1	-	-	0.50
e2	-	-	0.50
Z1	-	-	0.075
Z2	-	-	0.075
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

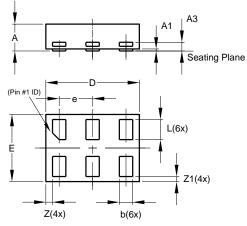
X2-DFN1409-6 CHIP SCALE ALTERNATIVE



Dimensions	Value (in mm)	
С	1.000	
C1	0.500	
D	0.300	
G	0.200	
G1	0.200	
Х	0.400	
Y	0.150	



Please see http://www.diodes.com/package-outlines.html for the latest version.

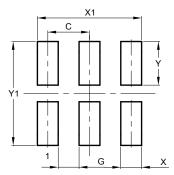


X2-DFN1410-6			
Dim	Min	Max	Тур
Α		0.40	0.39
A1	0.00	0.05	0.02
A3			0.13
b	0.15	0.25	0.20
D	1.35	1.45	1.40
Е	0.95	1.05	1.00
е			0.50
L	0.25	0.35	0.30
Z	_	_	0.10
Z1	0.045	0.105	0.075
All Dimensions in mm			

X2-DFN1410-6

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1410-6

Dimensions	Value (in mm)	
С	0.500	
G	0.250	
Х	0.250	
X1	1.250	
Y	0.525	
Y1	1.250	



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